

FORM PTO-1449 (MODIFIED)

ATTORNEY DOCKET NO.

SERIAL NO.

LIST OF PATENTS AND  
PUBLICATIONS

SP01-301

10/035,564

FOR APPLICANT'S INFORMATION  
DISCLOSURE STATEMENT

APPLICANT Sabia

FILING DATE October 26, 2001

GROUP: 2812

AUG 04 2003

RECEIVED  
AUG 08 2003  
TC 1700

## REFERENCE DESIGNATION

## U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub- Class	Filing Date if Approp.
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

## FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Sub- Class	Translation Yes No
	AL						
	AM						
	AN						
	AO						
	AP						
	AQ						

## OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

<i>JLR</i>	AR	Andreas Plohl et al., Wafer Direct Bonding: Tailoring Adhesion Between Brittle Materials, Materials Science and Engineering, R25 (1999) pp. 1-88.
	AS	
	AT	
	AU	
	AV	
	AW	

EXAMINER:

DATE CONSIDERED:

*Jessica L. Rossi**1/14/04*

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.